

RN73H

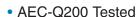
long term precision thin (metal) film flat chip resistors (high reliability, for automotive)

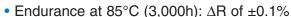


applications

- Automotive electronics
- Industrial equipment
- Measurement equipment

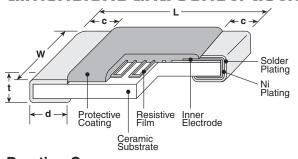
features



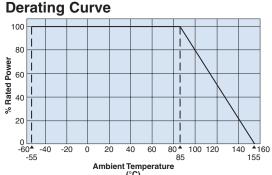


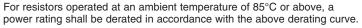
- High temperature exposure: ΔR of ±0.1%
- High precision type ±5% is available
- Low current noise
- High reliability and high stability at elevated temperatures
- Improved moisture resistance by glass passivation layer
- Products meet EU RoHS requirements
- Rated ambient temperature: 85°C, rated up to +155°C
- Sulfur resistance verified according to ASTM B 809-95

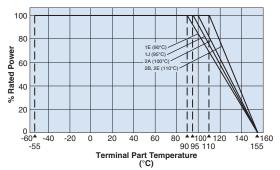
dimensions and construction



Type	Dimensions inches (mm)							
(Inch Size Code)	L W		С	d	t			
1E (0402)	.039 ^{+.004} ₀₀₂ (1.0 _{-0.05})	.020±.002 (0.5±0.05)	.010±.004 (0.25±0.1)	.010 ^{+.002} ₀₀₄ (0.25 ^{+0.05} _{-0.1})	.014±.002 (0.35±0.05)			
1J (0603)	.063±.008 (1.6±0.2)	.031±.004 (0.8±0.1)	.012±.004 (0.3±0.1)	.012±.004 (0.3±0.1)	.018±.004 (0.45±0.1)			
2A (0805)	.079±.008 (2.0±0.2)	.049±.008 (1.25±0.2)	.016±.008 (0.4±0.2)	.012 ^{+.008} ₀₀₄ (0.3 ^{+0.2} _{-0.1})	.02±.004 (0.5±0.1)			
2B (1206)	.126±.008	.063±.008 (1.6±0.2)	.02±.012	.016 +.008	.024±.004 (0.6±0.1)			
2E (1210)	(3.2±0.2)	.098±.008 (2.5±0.2)	(0.5±0.3)	(0.4 +0.2)				

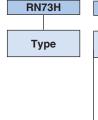






For resistors operated terminal part temperature of described for each size or above, a power rating shall be derated in accordance with derating curve. Please refer to "Introduction of the derating curves based on the terminal part temperature" in the beginning of our catalog before use.

ordering information





2B



Pack	aging
TP: 0402 only: punched p	
TD: 0603, 080 7" 4mm pi paper	5, 1206, 1210: tch punched

TD

7" 4mm pitch punched
paper
TE: 0805, 1206, 1210: 7" embossed plastic
For further information on packaging, please refer to Appendix A

1002					
Nominal Resistance					
3 sign	ificant				
figures	S +				
1 mult	iplier				
"R" ind	dicates				
decim	al on				
value	$<$ 100 Ω				

Resistance Tolerance
A: ±0.05%
B: ±0.1%
C: ±0.25%
D: ±0.5%
F: ±1.0%

25
T.C.R. (ppm/°C)
05
10
25
50
100

Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.

8/18/21





long term precision thin (metal) film flat chip resistors (high reliability, for automotive)

applications and ratings

Part Designation	Power Rating	Rated Ambient	Rated Terminal Part	T.C.R. (ppm/°C)	Resistance Range (Ω) E-24, E-96, E-192*				Maximum Working	Maximum Overload		
Designation		Temp.	Max.	(A±0.05%)	(B±0.1%)	(C±0.25%)	(D±0.5%)	(F±1.0%)	Voltage	Voltage		
			±10	_	47 - 100k	47 - 100k	47 - 100k	47 - 100k				
RN73H1E	RN73H1E 1/16W (.063W)	85°C	90°C	±25	_	47 - 300k	47 - 300k	47 - 300k	47 - 300k	50V	100V	
	(.00377)			±50	_	47 - 300k	47 - 300k	10 - 300k	10 - 300k			
			95°C	±5	100 - 59k	100 - 59k	_	_	_	75V	150V	
				±10	47 - 59k	47 - 360k	47 - 360k	47 - 360k	47 - 360k			
RN73H1J	1/10W (.10W)	1 00 0 1		±25	47 - 59k	15 - 1M	15 - 1M	10 - 1M	10 - 1M			
	(.1000)			±50	_	15 - 1M	15 - 1M	10 - 1M	10 - 1M			
				±100	_	_	_	10 - 1M	10 - 1M			
	1/8W RN73H2A (.125W)	/8W		±5	100 - 100k	100 - 100k	_	_	_	150V	300V	
				±10	47 - 100k	47 - 1M	47 - 1M	47 - 1M	47 - 1M			
RN73H2A		85°C	100°C	±25	47 - 100k	15 - 1.5M	15 - 1.5M	10 - 1.5M	10 - 1.5M			
	,	´			±50	_	15 - 1.5M	15 - 1.5M	10 - 1.5M	10 - 1.5M		
				±100	_	_	_	10 - 1.5M	10 - 1.5M			
	RN73H2B 1/4W (.25W)			±5	100 - 300k	100 - 300k	_	_			00V 400V	
		1/4W		±10	47 - 300k	47 - 1M	47 - 1M	47 - 1M	47 - 1M			
RN73H2B		85°C	110°C	±25	47 - 300k	15 - 1M	15 - 1M	10 - 1M	10 - 1M	200V		
				±50	_	15 - 1M	15 - 1M	10 - 1M	10 - 1M			
				±100	_	_	_	10 - 1M	10 - 1M			
			°C 110°C	±10	100 - 510k	100 - 510k	100 - 510k	100 - 510k	100 - 510k	200V	400V	
RN73H2E	1/4W			±25	51 - 510k	15 - 1M	15 - 1M	10 - 1M	10 - 1M			
HIV/3HZE	(.25W)	.25W) 85°C		±50	_	15 - 1M	15 - 1M	10 - 1M	10 - 1M			
			±100	_	_	_	10 - 1M	10 - 1M				

^{*} No marking on E-192 values

Operating Temperature: -55°C to +155°C

environmental applications

Performance Characteristics

	Requirement Δ R ±(%+0.05Ω)		
Parameter	Limit	Typical	Test Method
Resistance	Within specified tolerance	_	25°C
T.C.R.	Within specified T.C.R.	_	+25°C/+125°C: T.C.R. +5 (x10°K); +15°C/-55°C and +25°C/+155°C: other
Overload (Short time)	±0.05%	±0.01%	Rated Voltage x 2.5 or Max. overload voltage, whichever is less for 5 seconds
Resistance to Solder Heat	±0.05%*	±0.01%	260°C ± 5°C, 10 seconds ± 1 second
Rapid Change of Temperature	±0.1%*	±0.02%	1E, 1J, 2A: -55°C (30 minutes), +155°C (30 minutes), 1000 cycles 2B, 2E: -55°C (30 minutes), +155°C (30 minutes), 500 cycles
Moisture Resistance	±0.1%*	±0.05%	85°C ± 2°C, 85%±5%RH, 1000 hours; 1.5 hr ON, 0.5 hr OFF cycle
Endurance at 85°C	±0.1%*	±0.03%	85°C ± 2°C, 3000 hours, 1.5 hr ON, 0.5 hr OFF cycle
High Temperature Exposure	±0.1%*	±0.05%	+155°C, 1000 hours

^{*} Depends on resistance value, please contact KOA Speer for details.

Precautions for Use

- The properly and electrostatically measured taping materials are used for the components, but attention should be paid to the fact that there is some danger the parts absorb on the top tapes to cause a failure in the mounting and the parts are destructed by static electricity (1J, 2A, 2B, 2E: 1kV and more, 1E: 0.5kV and more at Human Body Model 100pF, 1.5kΩ) to change the resistance in the conditions of an excessive dryness or after the parts are given vibration for a long time as they are packaged on the tapes. Similarly, care should be given not to apply the excessive static electricity when mounting on the boards.
- Ionic impurities such as flux etc. that are attached to these products or those mounted onto a PCB, negatively affect their moisture resistance, corrosion resistance, etc. The flux may contain ionic substances like chlorine, acid, etc. while perspiration and saliva include ionic impurities like sodium (Na), chlorine (Cl–) etc. Therefore these kinds of ionic substances may induce electrical corrosion when they invade into the products. Either thorough washing or using RMA solder and flux are necessary since lead free solder contains ionic substances. Washing process is needed, before putting on moisture proof material in order to prevent electrical corrosion.
- The upper electrodes could be peeled off when a heat-resistant masking tape is attached to the mounted chip resistors and then detached from them. It is confirmed that the adhesiveness gets stronger due to the exposure to heat under mounting. Accordingly, we recommend the use of masking tape be refrained. If the use of heat-resistant masking tape is unavoidable, please make sure that the adhesives on the tape do not directly come in contact with the product.
- When high-pressure shower cleaning is implemented, there is a possibility of exfoliation of the top electrodes caused by the water pressure stress so please avoid the implementation.
- If the implementation is unavoidable, then please evaluate the products beforehand.

For Surface Temperature Rise Graph see Environmental Applications. Additional environmental applications can also be found at www.koaspeer.com Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.

9/30/19